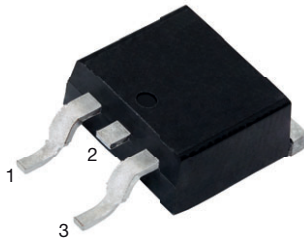
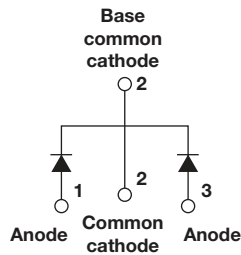


HEXFRED®

Ultrafast Soft Recovery Diode, 2 x 4 A


D²PAK (TO-263AB)

FEATURES

- Ultrafast and ultrasoft recovery
- Very low I_{RRM} and Q_{rr}
- Specified at operating conditions
- Meets MSL level 1, per J-STD-020, LF maximum peak of 245 °C
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


RoHS
 COMPLIANT
 HALOGEN
FREE
BENEFITS

- Reduced RFI and EMI
- Reduced power loss in diode and switching transistor
- Higher frequency operation
- Reduced snubbing
- Reduced parts count

DESCRIPTION

VS-HFA08TA60CS is a state of the art center tap ultrafast recovery diode. Employing the latest in epitaxial construction and advanced processing techniques it features a superb combination of characteristics which result in performance which is unsurpassed by any rectifier previously available. With basic ratings of 600 V and 4 A per leg continuous current, the VS-HFA08TA60CS is especially well suited for use as the companion diode for IGBTs and MOSFETs. In addition to ultrafast recovery time, the HEXFRED® product line features extremely low values of peak recovery current (I_{RRM}) and does not exhibit any tendency to “snap-off” during the t_b portion of recovery. The HEXFRED features combine to offer designers a rectifier with low noise and significantly lower switching losses in both the diode and the switching transistor. These HEXFRED advantages can help to significantly reduce snubbing, component count and heatsink sizes. The HEXFRED VS-HFA08TA60CS is ideally suited for applications in power supplies and power conversion systems (such as inverters), motor drives, and many other similar applications where high speed, high efficiency is needed.

PRIMARY CHARACTERISTICS

| | |
|-----------------------|------------------|
| $I_{F(AV)}$ | 8 A |
| V_R | 600 V |
| V_F at I_F | 2.2 V |
| t_{rr} (typ.) | 17 ns |
| T_J max. | 150 °C |
| Package | D²PAK (TO-263AB) |
| Circuit configuration | Common cathode |

ABSOLUTE MAXIMUM RATINGS

| PARAMETER | SYMBOL | TEST CONDITIONS | VALUES | UNITS |
|--|----------------|-----------------------|-----------------|-------|
| Cathode to anode voltage | V_R | | 600 | V |
| Maximum continuous forward current | I_F | $T_C = 100\text{ °C}$ | per leg 4 | A |
| | | | per device 8 | |
| Single pulse forward current | I_{FSM} | | 25 | |
| Maximum repetitive forward current | I_{FRM} | | 16 | |
| Maximum power dissipation | P_D | $T_C = 25\text{ °C}$ | 25 | W |
| | | $T_C = 100\text{ °C}$ | 10 | |
| Operating junction and storage temperature range | T_J, T_{Stg} | | -55 to +150 | °C |



| ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified) | | | | | | |
|---|-----------------|--|------|------|------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| Cathode to anode breakdown voltage | V _{BR} | I _R = 100 μA | 600 | - | - | V |
| Maximum forward voltage | V _{FM} | I _F = 4.0 A | - | 1.5 | 1.8 | |
| | | I _F = 8.0 A | - | 1.8 | 2.2 | |
| | | I _F = 4.0 A, T _J = 125 °C | - | 1.4 | 1.7 | |
| Maximum reverse leakage current | I _{RM} | V _R = V _R rated | - | 0.17 | 3.0 | μA |
| | | T _J = 125 °C, V _R = 0.8 x V _R rated | - | 44 | 300 | |
| Junction capacitance | C _T | V _R = 200 V | - | 4.0 | 8.0 | pF |
| Series inductance | L _S | Measured lead to lead 5 mm from package body | - | 8.0 | - | nH |

| DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified) | | | | | | |
|--|---------------------------|---|------|------|------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| Reverse recovery time See fig. 5, 6 and 16 | t _{rr} | I _F = 1.0 A, di _F /dt = 200 A/μs, V _R = 30 V | - | 17 | - | ns |
| | t _{rr1} | T _J = 25 °C | - | 28 | 42 | |
| | t _{rr2} | T _J = 125 °C | - | 38 | 57 | |
| Peak recovery current See fig. 7 and 8 | I _{RRM1} | T _J = 25 °C | - | 2.9 | 5.2 | A |
| | I _{RRM2} | T _J = 125 °C | - | 3.7 | 6.7 | |
| Reverse recovery charge See fig. 9 and 10 | Q _{rr1} | T _J = 25 °C | - | 40 | 60 | nC |
| | Q _{rr2} | T _J = 125 °C | - | 70 | 105 | |
| Peak rate of fall of recovery current during t _b See fig. 11 and 12 | di _{(rec)M} /dt1 | T _J = 25 °C | - | 280 | - | A/μs |
| | di _{(rec)M} /dt2 | T _J = 125 °C | - | 235 | - | |

| THERMAL - MECHANICAL SPECIFICATIONS | | | | | | |
|---|-------------------|--|--------------|------|------------|------------------------|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| Lead temperature | T _{lead} | 0.063" from case (1.6 mm) for 10 s | - | - | 300 | °C |
| Thermal resistance, junction to case | R _{thJC} | | - | - | 5.0 | K/W |
| Thermal resistance, junction to ambient | R _{thJA} | Typical socket mount | - | - | 80 | |
| Weight | | | - | 2.0 | - | g |
| | | | - | 0.07 | - | oz. |
| Mounting torque | | | 6.0 (5.0) | - | 12 (10) | kgf · cm (lbf · in) |
| Marking device | | Case style D ² PAK (TO-263AB) | HFA08TA60CS | | | |

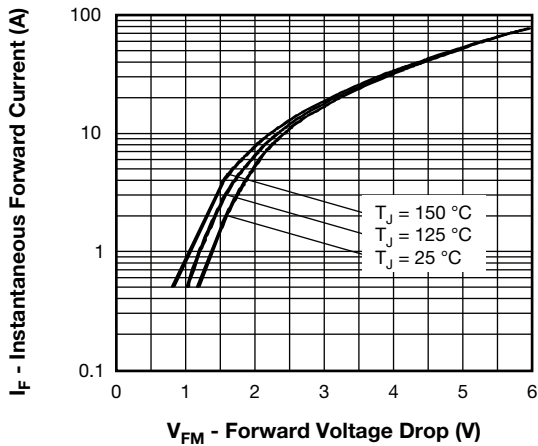


Fig. 1 - Maximum Forward Voltage Drop vs. Instantaneous Forward Current

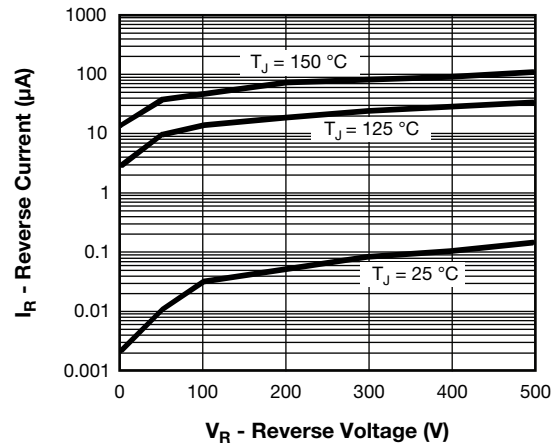


Fig. 2 - Typical Reverse Current vs. Reverse Voltage

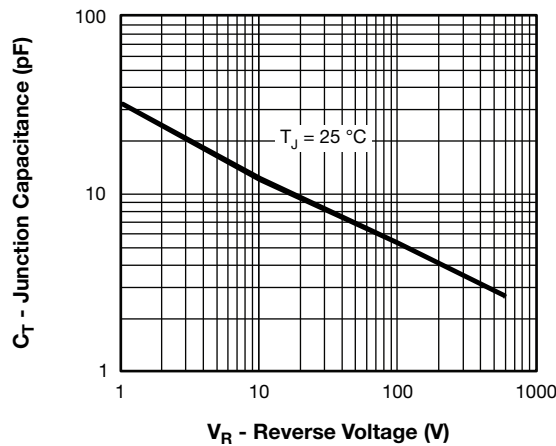


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

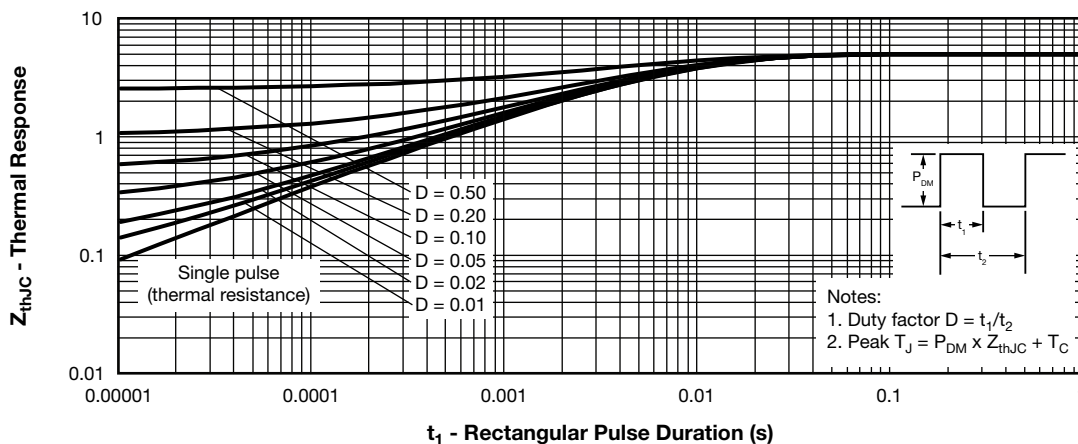


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

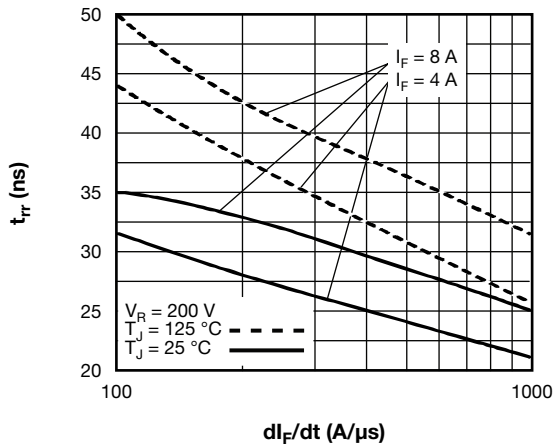


Fig. 5 - Typical Reverse Recovery Time vs. di_F/dt

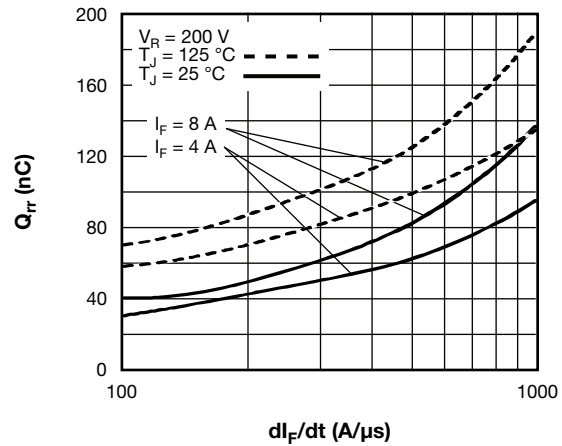


Fig. 7 - Typical Stored Charge vs. di_F/dt

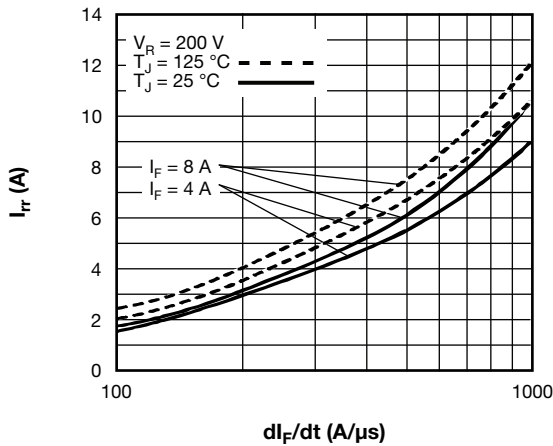


Fig. 6 - Typical Recovery Current vs. di_F/dt

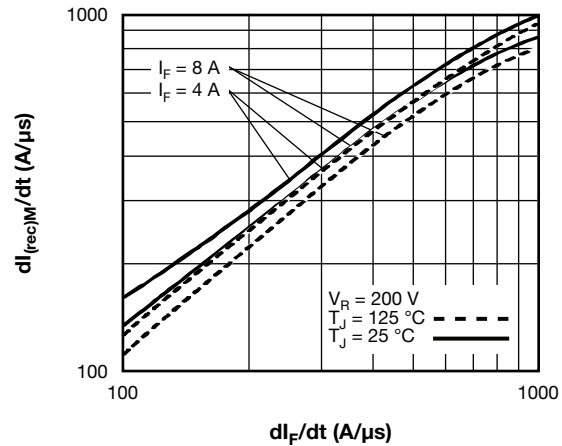
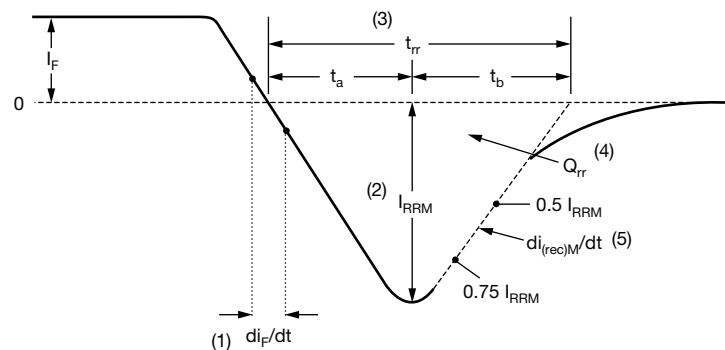


Fig. 8 - Typical $di_{(rec)M}/dt$ vs. di_F/dt



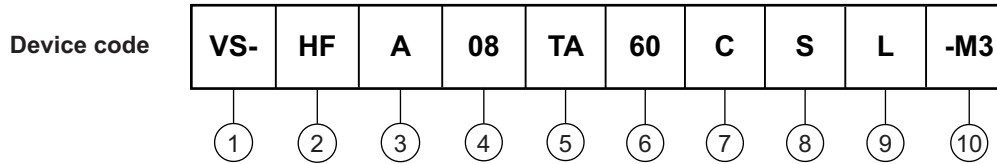
- (1) di_F/dt - rate of change of current through zero crossing
- (2) I_{RRM} - peak reverse recovery current
- (3) t_{rr} - reverse recovery time measured from zero crossing point of negative going I_F to point where a line passing through $0.75 I_{RRM}$ and $0.50 I_{RRM}$ extrapolated to zero current.
- (4) Q_{rr} - area under curve defined by t_{rr} and I_{RRM}
- (5) $di_{(rec)M}/dt$ - peak rate of change of current during t_b portion of t_{rr}

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

Fig. 9 - Reverse Recovery Waveform and Definitions



ORDERING INFORMATION TABLE



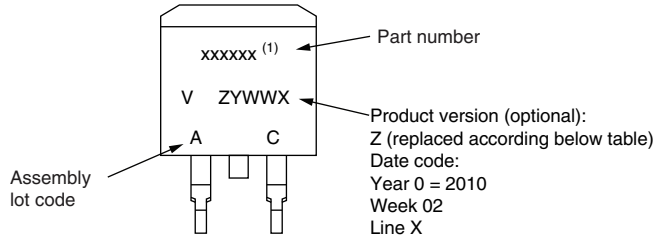
- 1** - Vishay Semiconductors product
- 2** - HEXFRED® family
- 3** - Process designator: A = electron irradiated
- 4** - Current rating (08 = 8 A)
- 5** - Package outline (TA = TO-220, 3 leads)
- 6** - Voltage rating (60 = 600 V)
- 7** - Circuit configuration (C = common cathode)
- 8** - S = D²PAK (TO-263AB)
- 9** -
 - None = tube (50 pieces)
 - L = tape and reel (left oriented)
 - R = tape and reel (right oriented)
- 10** - Environmental digit:
 - M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

| ORDERING INFORMATION (Example) | | | |
|---------------------------------------|-------------------|------------------------|-------------------------|
| PREFERRED P/N | QUANTITY PER TUBE | MINIMUM ORDER QUANTITY | PACKAGING DESCRIPTION |
| VS-HFA08TA60CS-M3 | 50 | 1000 | Antistatic plastic tube |
| VS-HFA08TA60CSR-M3 | 800 | 800 | 13" diameter reel |
| VS-HFA08TA60CSL-M3 | 800 | 800 | 13" diameter reel |

| LINKS TO RELATED DOCUMENTS | |
|-----------------------------------|--|
| Dimensions | www.vishay.com/doc?96164 |
| Part marking information | www.vishay.com/doc?95444 |
| Packaging information | www.vishay.com/doc?96424 |



D²PAK



Example: This is a xxxxxx ⁽¹⁾ with assembly lot code AC, assembled on WW 02, 2010

Note

⁽¹⁾ If part number contain "H" as last digit, product is AEC-Q101 qualified

| ENVIRONMENTAL NAMING CODE (Z) | PRODUCT DEFINITION |
|-------------------------------|--|
| A | Termination lead (Pb)-free |
| B | Totally lead (Pb)-free |
| E | RoHS-compliant and termination lead (Pb)-free |
| F | RoHS-compliant and totally lead (Pb)-free |
| M | Halogen-free, RoHS-compliant, and termination lead (Pb)-free |
| N | Halogen-free, RoHS-compliant, and totally lead (Pb)-free |
| G | Green |

D²PAK

DIMENSIONS in millimeters and inches

Conforms to JEDEC[®] outline D²PAK (SMD-220)



| SYMBOL | MILLIMETERS | | INCHES | | NOTES | SYMBOL | MILLIMETERS | | INCHES | | NOTES |
|--------|-------------|-------|--------|-------|-------|--------|-------------|-------|-----------|-------|-------|
| | MIN. | MAX. | MIN. | MAX. | | | MIN. | MAX. | MIN. | MAX. | |
| A | 4.06 | 4.83 | 0.160 | 0.190 | | D1 | 6.86 | 8.00 | 0.270 | 0.315 | 3 |
| A1 | 0.00 | 0.254 | 0.000 | 0.010 | | E | 9.65 | 10.67 | 0.380 | 0.420 | 2, 3 |
| b | 0.51 | 0.99 | 0.020 | 0.039 | | E1 | 7.90 | 8.80 | 0.311 | 0.346 | 3 |
| b1 | 0.51 | 0.89 | 0.020 | 0.035 | 4 | e | 2.54 BSC | | 0.100 BSC | | |
| b2 | 1.14 | 1.78 | 0.045 | 0.070 | | H | 14.61 | 15.88 | 0.575 | 0.625 | |
| b3 | 1.14 | 1.73 | 0.045 | 0.068 | 4 | L | 1.78 | 2.79 | 0.070 | 0.110 | |
| c | 0.38 | 0.74 | 0.015 | 0.029 | | L1 | - | 1.65 | - | 0.066 | 3 |
| c1 | 0.38 | 0.58 | 0.015 | 0.023 | 4 | L2 | 1.27 | 1.78 | 0.050 | 0.070 | |
| c2 | 1.14 | 1.65 | 0.045 | 0.065 | | L3 | 0.25 BSC | | 0.010 BSC | | |
| D | 8.51 | 9.65 | 0.335 | 0.380 | 2 | L4 | 4.78 | 5.28 | 0.188 | 0.208 | |

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inches
- (7) Outline conforms to JEDEC[®] outline TO-263AB



D²PAK (TO-263AB)

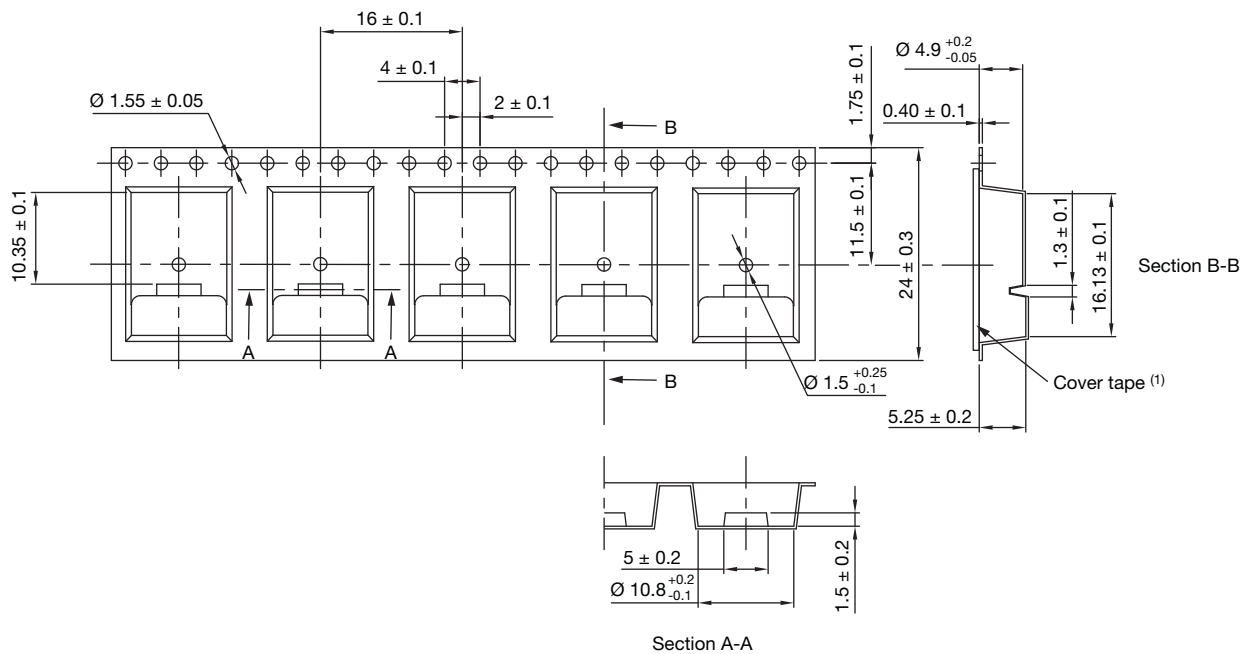
CARRIER TAPE FOR TAPE AND REEL LEFT in millimeters



Note

(1) For dimensions, see next pages

CARRIER TAPE FOR TAPE AND REEL RIGHT in millimeters



Note

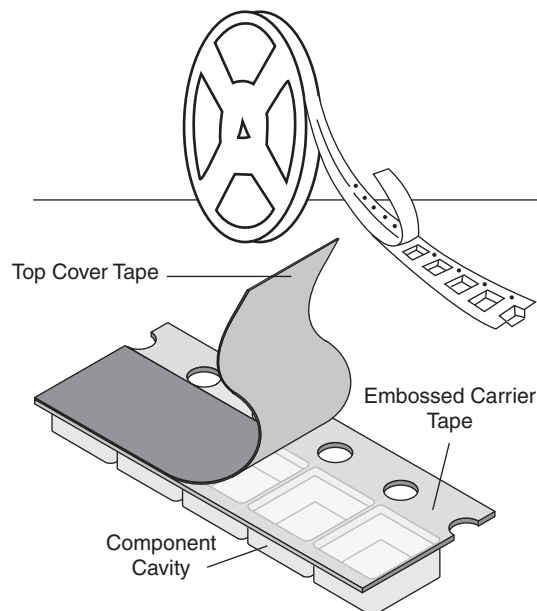
(1) For dimensions, see next pages



REEL FOR CARRIER TAPE in millimeters

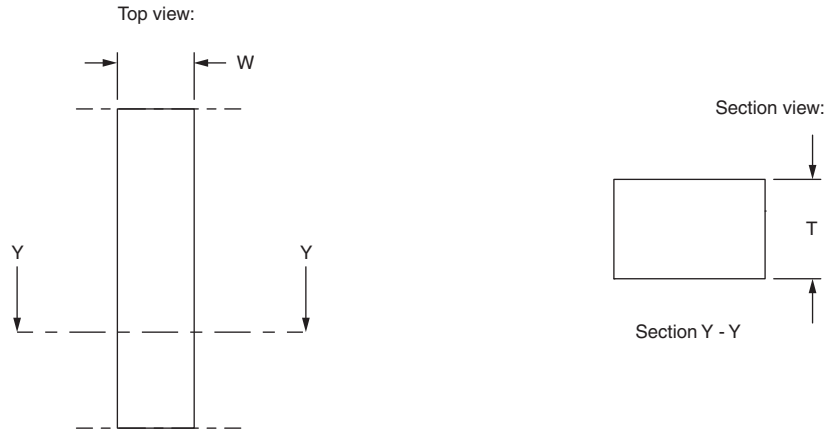


CARRIER TAPE AND REEL PACKAGING D²PAK (TO-263AB)





COVER TAPE FOR CARRIER TAPE in millimeters



| APPLICATION | COVER TAPE WIDTH W | COVER TAPE THICKNESS T | CARRIER TAPE WIDTH | MATERIAL |
|----------------------------------|-----------------------|---------------------------|--------------------|--|
| D ² PAK (TO-263AB) | 21.3 ± 0.1 | 0.060 ± 0.01 | 24 | Antistatic/treated/transparent/polyester |



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